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FORM PTO-144 S. DEPARTMENT OF COMMERCE (Modified) PAGE TRADEMARK OFFICE	ATTY. DOCKET NO. 5740.02	SERIAL NO. 09/812,140		
INFORMATION DISCLOSURE STATEMENT BY APPLICANT	APPLICANT: Neuhaus, et al			
(Use several sheets if necessary)	FILING DATE March 19, 2001	GROUP 2841		

## U.S. PATENT DOCUMENTS

EXAMINER INITIAL	PATENT NUMBER	ISSUE DATE	PATENTEE	CLASS	SUBCLASS	FILING DATE IF APPROPRIATE

## FOREIGN PATENT OR PUBLISHED FOREIGN PATENT APPLICATION

	DOCUMENT	PUBLISHED DATE	CLASS	SUBCLASS	TRANSLATION	
	NUMBER				YES	NO
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## OTHER DOCUMENTS (Including Author, Title, Date, Pertinent Pages, Etc.)

GN	Dr. Herbert J. Neuhaus et al.	"Manufacturing and Reliability of Chip Module to Antenna Coil Contacts in Dual Interface Smart Cards"	Int'l Microelectronics and Packaging Society Symposium; October 1999
or	Dr. Herbert J. Neuhaus	"Advances in Materials for Low Cost Flip-Chip"	Advancing Microelectronics, Vol. 27, No. 4 July/August 2000, pp.12-14
	Dr. Michael E. Wernle	"Manufacturing of Low Cost Smart Labels"	Int'l Microelectronics Symposium; September 2000
	EXAMINER /	211711/1-	DATE CONSIDERED 1/2/2

EXAMINER: Initial if citation considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.